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U 1 Document ID Issue Date Pages Title Current OR Current Ref Inventor S




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- ☒ L1: (11222) 455/130 455/131 455/141 455/150.1 455/140 455/269 455/29
- ☒ L2: (433) 1 and ("direct conversion receiver" or "direct conversion tran
- ☒ L3: (47) 2 and shield\$3
- ☒ L4: (26) 3 and substrate
- ☒ L5: (3) 4 and (shield\$3 near5 surface)
- ☒ L6: (3) 4 and shield\$3.clm.
- ☒ L7: (1) 6 and "dielectric layer".clm.
- ☒ L8: (1) 7 and "positive hole".clm.

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- ☒ S1: (1) ("6175728").PN.
- ☒ S2: (1382) "direct conversion receiver" or "direct conversion transceiver"
- ☒ S3: (124) S2 and shield\$3
- ☒ S4: (75) S3 and substrate
- ☒ S5: (69) S4 and mixer
- ☒ S6: (62) S5 and (LO or "local oscillator")
- ☒ S7: (3) S6 and (shield\$3 near5 surface)
- ☒ S8: (2) (("6175728") or ("6360087")).PN.
- ☒ S9: (1) S6 and (mixer near8 block\$3 near8 "local oscillator")
- ☒ S10: (1) (US-20040185811-\$).did.
- ☒ S11: (154486) 455/130 455/131 455/141 "455" "150.1" 455/140 455/269
- ☒ S12: (600) S11 and ("direct conversion receiver" or "direct conversion

(19) United States  
(12) Patent Application Publication (19) Pub. No.: US 2004/0185811 A1  
Woo et al. (12) Pub. Date: Sep. 23, 2004

(34) SINGLE CHIP DIRECT CONVERSION  
TRANSMITTER FOR REDUCING DC  
OFFSET AND METHOD OF  
MANUFACTURING THE SAME

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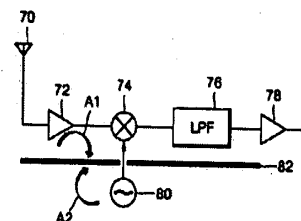
(21) Appl. No.: 10/767,089

(22) Filed: Jan. 23, 2004

(37) Foreign Application Priority Data  
Jan. 24, 2003 (KR) 2003-001270

Publication Classification  
(51) Int. Cl.<sup>7</sup> H04B 1/00  
(52) U.S. Cl. 455/131, 455/293

**ABSTRACT**  
A single chip direct conversion transmitter that includes a substrate on which a mixer unit and a local oscillator are provided as a circuit, and a positive hole formed between the mixer unit and the local oscillator and filled with a conductive plug to block signal leakage. A shield ground surface is formed above the substrate and blocks signal leakage occurring when the signals received through the antenna are input into the mixer and signal leakage occurring when the reference signal is input into the mixer from the local oscillator. A first interconnect is formed above the shield ground surface and connects the mixer unit and the local oscillator. The interconnects are formed between the substrate and the shield ground surface not on the shield ground surface to connect the first interconnect.



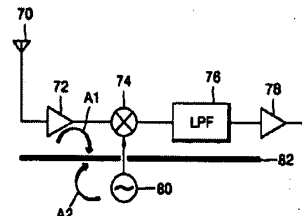
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1	<input type="checkbox"/>	<input checked="" type="checkbox"/>	US 20040185811 A1	20040923	14	Single chip direct conversion transceiver for reducing DC o	455/131	455/293		Woo, Sang-Hyun et al.	

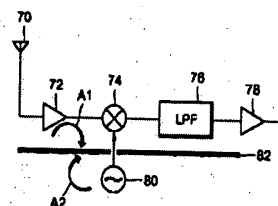
- ## A Presentation



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1	<input type="checkbox"/>	<input checked="" type="checkbox"/>	US 20040185811 A1	20040923	14	Single chip direct conversion transceiver for reducing DC o	455/131	455/293		Woo, Sang-Hyun et al.
2	<input type="checkbox"/>	<input checked="" type="checkbox"/>	US 20030032401 A1	20030213	11	Direct conversion transceiver capable of reducing DC offset	455/217	455/117; 455/300;		Woo, Sang-hyun et al.

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2	<input type="checkbox"/>	<input checked="" type="checkbox"/>	US 20030032401 A1	20030213	11	Direct conversion transceiver capable of reducing DC offset	455/217	455/117; 455/300;	Woo, Sang-hyun et al.
3	<input type="checkbox"/>	<input checked="" type="checkbox"/>	US 6944436 B2	20050913	11	Direct conversion transceiver capable of reducing DC offset	455/317	455/114.1; 455/114.2	Woo, Sang-hyun et al.

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- L3: (124) 2 and shield\$3
- L4: (75) 3 and substrate
- L5: (69) 4 and mixer
- L6: (62) 5 and (LO or "local oscillator")
- L7: (3) 6 and (shield\$3 near5 surface)
- L8: (2) (("6175728") or ("6360087")).PN.
- L9: (1) 6 and (mixer near8 block\$3 near8 "local oscillator")
- L10: (1) (US-20040185811-\$).did.
- L11: (154486) 455/130 455/131 455/141 "455" "150.1" 455/140 455/26
- L12: (600) 11 and ("direct conversion receiver" or "direct conversion
- L13: (61) 12 and shield\$3
- L14: (60) 13 and mixer
- L15: (57) 14 and (LO or "local oscillator")
- L16: (31) 15 and substrate
- L17: (3) 16 and (shield\$3 near5 surface)

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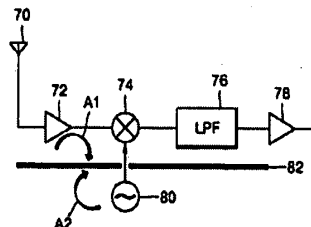
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**077 ABSTRACT**

A single chip silicon monolithic microwave thin film device is fabricated on which a mixer and a local oscillator are provided on a dielectric and a positive bias formed between the mixer and the local oscillator and filled with a conductive paste to block signal leakage. A shield ground surface is formed above the substrate and blocks signal leakage occurring when the signals received through the antenna are input into the mixer and signal leakage occurring when the oscillator signal is input into the mixer. When the local oscillator is a first intermediate frequency is formed above the shield ground surface and connects the mixer and the local oscillator. Diode-like layers are formed between the substrate and the shield ground surface and on the shield ground surface to carry the first intermediate frequency.



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